## **Electronic Acknowledgement Receipt** FES ID: 1066002 Application Number: 10053963 Confirmation Number: 5214 Title of Invention: Die assembly and method for forming a die on a wafer First Named Inventor: Aron T. Lunde Deborah K. Henscheid, Esq. Snell & Wilmer, L.L.P. One Arizona Center Correspondence Address: 400 E. Van Buren Phoenix ΑZ 85004-2202 US 6023826070 Filer: J. Damon Ashcraft/Julie Eslick Filer Authorized By: J. Damon Ashcraft Attorney Docket Number: 37829.0400 Receipt Date: 02-JUN-2006 Filing Date: 22-JAN-2002 Time Stamp: 18:12:48 Application Type: Utility International Application Number: Payment information:

no

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## File Listing:

Number	Document Description	File Name	File Size(Bytes)	Part	Pages
1	Change of Address	378290400COA.pdf	46902	no	1
Warnings:					
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## New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be Issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.